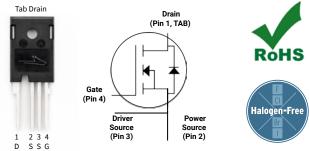


C3M0040120K

1200V 40mohm Silicon Carbide Power MOSFET N-Channel Enhancement Mode

Features

- 3rd generation SiC MOSFET technology
- Optimized package with separate driver source pin
- 8mm of creepage distance between drain and source
- High blocking voltage with low on-resistance
- High-speed switching with low capacitances
- Fast intrinsic diode with low reverse recovery (Q_{rr})
- Halogen free, RoHS compliant



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Part Number	Package	Marking
C3M0040120K	TO-247-4	C3M0040120K

Applications

- Solar inverters
- EV motor drive
- High voltage DC/DC converters
- Switched mode power supplies
- Load switch

Benefits

- Reduce switching losses and minimize gate ringing
- Higher system efficiency
- Reduce cooling requirements
- Increase power density
- Increase system switching frequency

Maximum Ratings (T_c = 25°C unless otherwise specified)

Parameter	Symbol	Value	Unit	Test Conditions	Note	
Drain-Source Voltage	V _{DS max}	1200		$V_{GS} = 0 V, I_{D} = 100 \mu A$		
Gate-Source Voltage (dynamic) ¹	V _{GS max}	-8/+19	V	AC (<i>f</i> >1 Hz)	Note 1	
Gate - Source Voltage (static) ²	V _{GSop}	-4/+15		Static		
Continuous Drain Current		66		$V_{GS} = 15 \text{ V}, T_{C} = 25^{\circ}\text{C}$	Fig. 19 Note 2	
Continuous Drain Current	ID	48	A	V _{GS} = 15 V, T _C = 100°C		
Pulsed Drain Current	I _{DM}	223		Pulse width t_P limited by $T_{j max}$	Fig. 22 Note 2	
Power Dissipation ²	PD	326	w	T _c = 25°C, T _J = 175°C	Fig. 20	
Operating Junction and Storage Temperature	T _J , T _{stg}	-40 to +175	°C			
Solder Temperature	Ts	260		According to JEDEC J-STD-020		
Mounting Torque	M _s	1	N-m	(M3 or 6-32 screw)		
	, ''s	8.8	lbf-in			

Note:

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¹ Recommended turn-off/turn on gate voltage V_{GS max} = -4V...0V/+15V

² Verified by design



Electrical Characteristics ($T_c = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Conditions	Note	
Drain-Source Breakdown Voltage	V _{(BR)DSS}	1200	—	-		$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 100 \mu\text{A}$		
Gate Threshold Voltage		1.8	2.7	3.6	v	$V_{DS} = V_{GS}$, $I_D = 9.2$ mA, $T_J = 25^{\circ}$ C	Fig. 11	
Gate Threshold Voltage	V _{GS(th)}	_	2.2	-		$V_{DS} = V_{GS}$, $I_{D} = 9.2$ mA, $T_{J} = 175^{\circ}$ C	Fig. 11	
Zero Gate Voltage Drain Current	I _{DSS}	-	1	50	μΑ	$V_{DS} = 1200 \text{ V}, V_{GS} = 0 \text{ V}$		
Gate-Source Leakage Current	I _{GSS}	-	10	250	nA	$V_{GS} = 15 V, V_{DS} = 0 V$		
Drain Course On State Desistance	_	-	40	53.5		$V_{GS} = 15 \text{ V}, \text{ I}_{D} = 33.3 \text{ A}$	Fig.	
Drain-Source On-State Resistance	R _{DS(on)}	_	68	_	mΩ	V _{GS} = 15 V, I _D = 33.3 A, T _J = 175°C	4, 5, 6	
Transcenductoria	-		21		S	V _{DS} = 20 V, I _{DS} = 33.3 A	F i= 7	
Transconductance	g _{fs}	_	20] —	5	$V_{DS} = 20 \text{ V}, I_{DS} = 33.3 \text{ A}, T_{J} = 175^{\circ}\text{C}$	- Fig. 7	
Input Capacitance	C _{iss}	_	2900	_			Fig. 17, 18	
Output Capacitance	C _{oss}	_	103	_	pF	$V_{GS} = 0 V, V_{DS} = 1000 V$ f = 100 khz		
Reverse Transfer Capacitance	C _{rss}	_	5	_		$V_{AC} = 25 \text{ mV}$		
C _{oss} Stored Energy	E _{oss}	_	60	_	μJ		Fig. 16	
Turn-On Switching Energy (SiC Diode FWD)	Eon	_	243	_			Fig. 26	
Turn Off Switching Energy (SiC Diode FWD)	E _{off}	_	104	_		$V_{DS} = 800 V, V_{GS} = -4 V/15 V,$ $I_{D} = 33.3 A, R_{G(ext)} = 2.5 \Omega,$ $L = 99 \mu H, T_{L} = 175^{\circ}C$		
Turn-On Switching Energy (Body Diode FWD)	E _{on}	_	611	_	μJ			
Turn-Off Switching Energy (Body Diode FWD)	E _{off}	_	99	_				
Turn-On Delay Time	t _{d(on)}	_	13	_		$V_{DD} = 800 \text{ V}, V_{GS} = -4 \text{ V}/15 \text{ V}$		
Rise Time	tr	_	17	_		$I_D = 33.3 \text{ A}, R_{G(ext)} = 2.5 \Omega,$		F:- 07
Turn-Off Delay Time	$t_{d(off)}$	_	23	_	ns	L= 99 μH Timing relative to V _{DS}	Fig. 27	
Fall Time	t _f	_	9	_		Inductive load		
Internal Gate Resistance	R _{G(int)}	_	3.5	_	Ω	<i>f</i> = 1 MHz, V _{AC} = 25 mV		
Effective Output Capacitance (Energy Related)	C _{O(er)}	_	127	_			Nata 2	
Effective Output Capacitance (Time Related)	C _{o(tr)}	_	197	_	pF	$V_{GS} = 0V, V_{DS} = 0800V$	Note 3	
Gate to Source Charge	Q _{gs}	_	34	_		V _{DS} = 800 V, V _{GS} = -4 V/15 V		
Gate to Drain Charge	Q _{gd}	_	28	_	nC	I _D = 33.3 A	Fig. 12	
Total Gate Charge	Qg	_	99	_]	Per IEC60747-8-4 pg 21		

Note:

 3 C_{O(er)}, a lumped capacitance that gives the same stored energy as Coss while Vds is rising from 0 to 800V C_{o(tr)}, a lumped capacitance that gives the same charging time as Coss while Vds is rising from 0 to 800V

Rev. 02, August 2023



Reverse Diode Characteristics ($T_c = 25^{\circ}C$ unless otherwise specified)

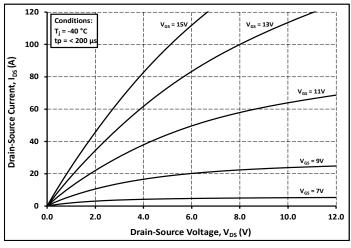
Parameter	Symbol	Тур.	Max.	Unit	Test Conditions	Notes
Diode Forward Voltage	N	5.5	_	V	$V_{GS} = -4 V$, $I_{SD} = 20 A$, $T_{J} = 25^{\circ}C$	Fig.
	V _{SD}	4.9	_		V _{GS} = -4 V, I _{SD} = 20 A, T _J = 175°C	8, 9, 10
Continuous Diode Forward Current	ls	_	51		V _{GS} = -4 V, T _J = 25°C	
Diode Pulse Current	I _{SM}	_	223	A	V _{GS} = -4 V, pulse width t _P limited by T _{j max}	
Reverse Recovery Time	t _{rr}	17	_	ns	$V_{GS} = -4 V, I_{SD} = 33.3 A, V_{R} = 800 V$	
Reverse Recovery Charge	Q _{rr}	850	_	nC	$T_{J} = 175^{\circ}C, di_{F}/dt = 7725 A/\mu s,$	
Peak Reverse Recovery Current	I _{RRM}	79	_	A	T _J = 175°C	
Reverse Recovery Time	t _{rr}	33	_	ns	$V_{GS} = -4 V, I_{SD} = 33.3 A, V_{R} = 800 V$	
Reverse Recovery Charge	Q _{rr}	691	_	nC	$T_{J} = 175^{\circ}C, di_{F}/dt = 2325 A/\mu s,$	
Peak Reverse Recovery Current	I _{RRM}	30	_	A	T _J = 175°C	

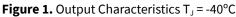
Thermal Characteristics

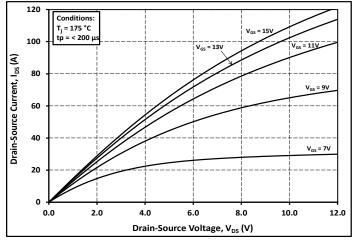
Parameter	Symbol	Тур	Unit	Note
Thermal Resistance from Junction to Case	$R_{ extsf{ heta}JC}$	0.46	°C/W	Fig. 21

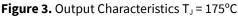
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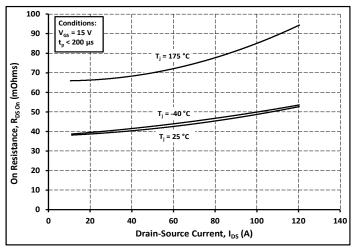


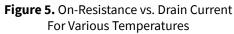


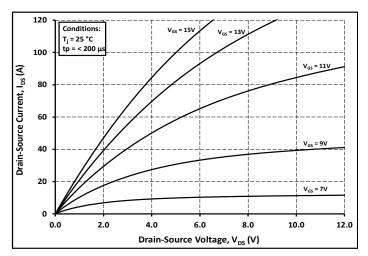


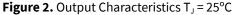












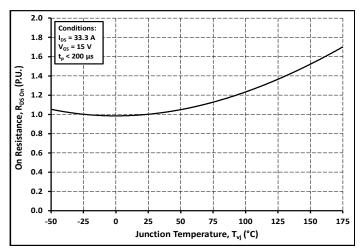


Figure 4. Normalized On-Resistance vs. Temperature

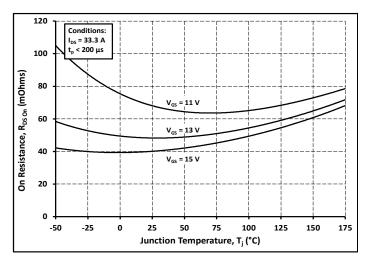
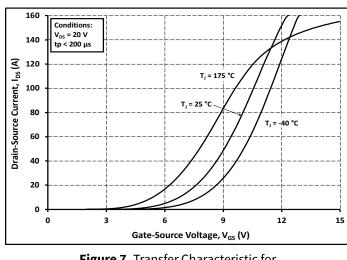
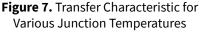


Figure 6. On-Resistance vs. Temperature For Various Gate Voltage

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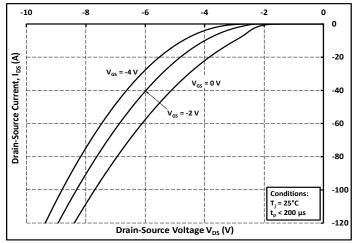
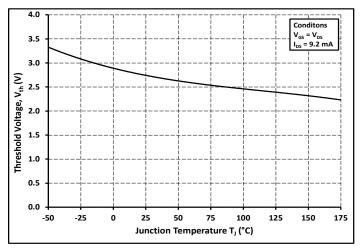
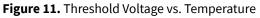


Figure 9. Body Diode Characteristic at 25°C





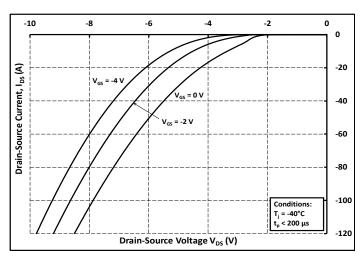


Figure 8. Body Diode Characteristic at -40°C

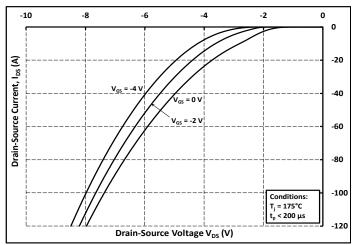
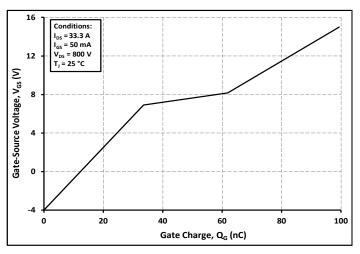
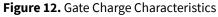


Figure 10. Body Diode Characteristic at 175°C







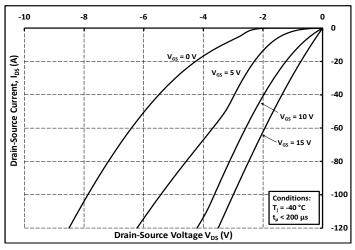


Figure 13. 3rd Quadrant Characteristic at -40°C

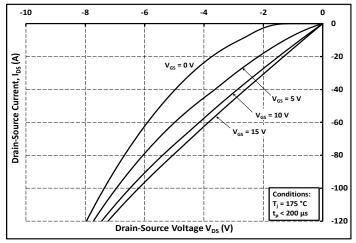
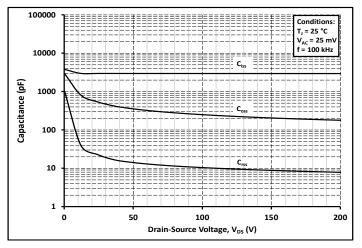
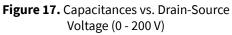


Figure 15. 3rd Quadrant Characteristic at 175°C





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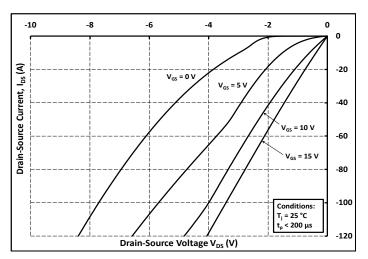


Figure 14. 3rd Quadrant Characteristic at 25°C

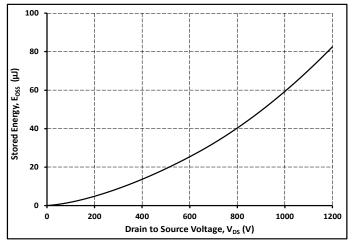


Figure 16. Output Capacitor Stored Energy

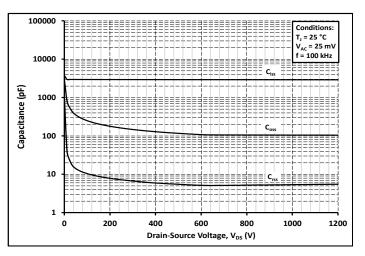
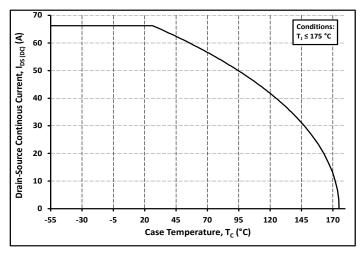


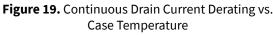
Figure 18. Capacitances vs. Drain-Source Voltage (0 - 1200 V)

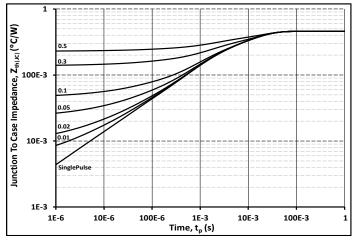
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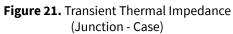
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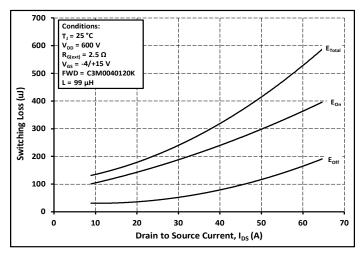


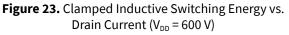












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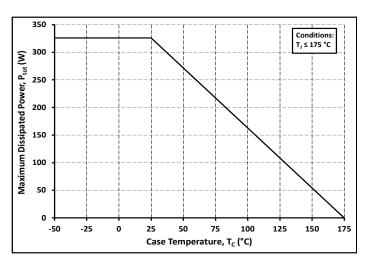


Figure 20. Maximum Power Dissipation Derating vs. **Case Temperature**

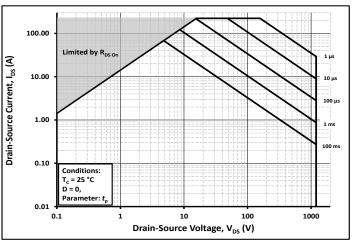


Figure 22. Safe Operating Area

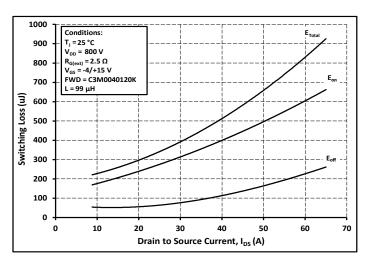


Figure 24. Clamped Inductive Switching Energy vs. Drain Current ($V_{DD} = 800 V$)

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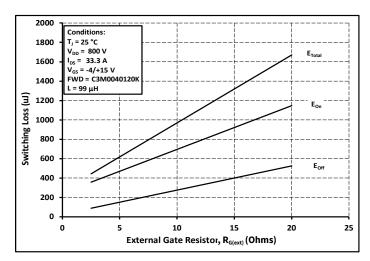


Figure 25. Clamped Inductive Switching Energy vs. R_{G(ext)}

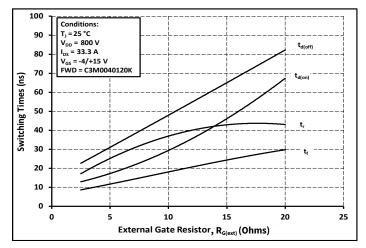


Figure 27. Switching Times vs. R_{G(ext)}

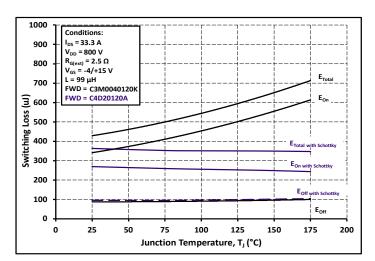


Figure 26. Clamped Inductive Switching Energy vs. Temperature

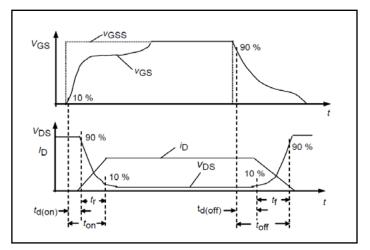


Figure 28. Switching Times Definition

8



Test Circuit Schematic

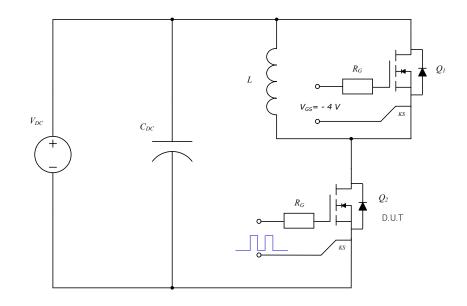


Figure 29. Clamped Inductive Switching Waveform Test Circuit

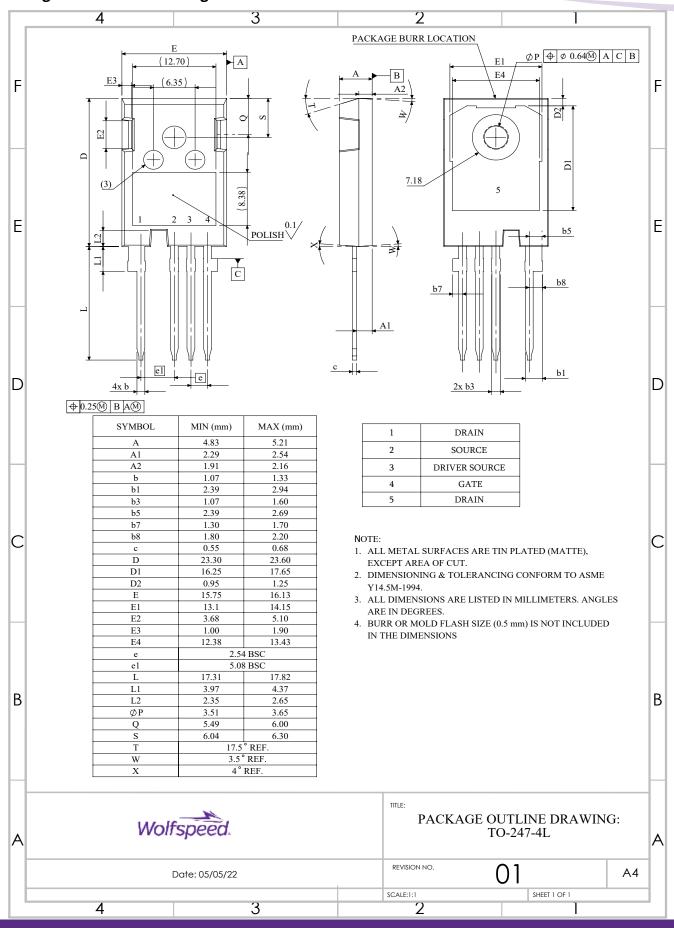
Note:

Turn-off and Turn-on switching energy and timing values measured using SiC MOSFET Body Diode as shown above.

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Package Dimensions - Package TO-247-4L



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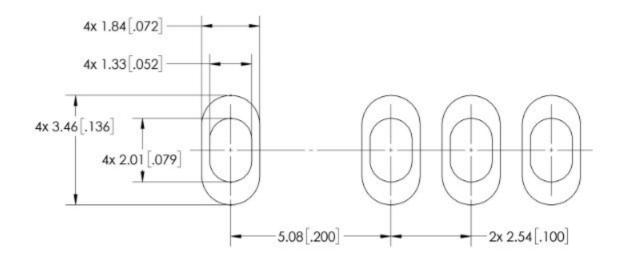
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Recommended Solder Pad Layout



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Related Links



- SPICE Models
- SiC MOSFET Isolated Gate Driver reference design
- SiC MOSFET Evaluation Board

Revision History

Document Version	Date of Release	Description of Changes
1	October-2020	Initial Release
2	August-2023	ID Pulse test conditions Updated Package Drawing Updated Landing Pad

Rev. 02, August 2023



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The Silicon Carbide MOSFET module switches at speeds beyond what is customarily associated with IGBT-based modules. Therefore, special precautions are required to realize optimal performance. The interconnection between the gate driver and module housing needs to be as short as possible. This will afford optimal switching time and avoid the potential for device oscillation. Also, great care is required to insure minimum inductance between the module and DC link capacitors to avoid excessive VDS overshoot.

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Wolfspeed representative or from the Product Documentation sections of www.wolfspeed.com.

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REACh substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact your Wolfspeed representative to ensure you get the most up-to-date REACh SVHC Declaration. REACh banned substance information (REACh Article 67) is also available upon request.

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